# ne<mark>x</mark>peria

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Kind regards,

Team Nexperia



# 1 A low V<sub>F</sub> MEGA Schottky barrier rectifier Rev. 01 — 17 March 2010

Product data sheet

#### 1. **Product profile**

#### 1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

#### 1.2 Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 1 A
- Reverse voltage: V<sub>R</sub> ≤ 60 V
- Low forward voltage
- High power capability due to clip-bond technology
- AEC-Q101 qualified
- Small and flat lead SMD plastic package

### 1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- Reverse polarity protection
- Low power consumption applications

### 1.4 Quick reference data

#### Table 1. Quick reference data

 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

J = = =	· · · · · · · · · · · · · · · · · · ·					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	square wave; $\delta = 0.5;$ f = 20 kHz				
		$T_{amb} \le 115 \ ^{\circ}C$	<u>[1]</u> -	-	1	А
		$T_{sp} \le 145 \ ^{\circ}C$	-	-	1	А
V <sub>R</sub>	reverse voltage		-	-	60	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A	-	460	530	mV
I <sub>R</sub>	reverse current	$V_R = 60 V$	-	30	60	μA

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.



1 A low V<sub>F</sub> MEGA Schottky barrier rectifier

### 2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	e Graphic symbol
1	cathode	[1]	54
2	anode	1	1 🕂 2
			sym001

[1] The marking bar indicates the cathode.

### 3. Ordering information

Table 3. Orde	ering infor	nation	
Type number	Package		
	Name	Description	Version
PMEG6010EP	-	plastic surface-mounted package; 2 leads	SOD128

### 4. Marking

Table 4. Marking codes	
Type number	Marking code
PMEG6010EP	A9

### 5. Limiting values

#### Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C	-	60	V
I <sub>F(AV)</sub>	average forward current	square wave; $\delta$ = 0.5; f = 20 kHz			
		$T_{amb} \leq 115 \ ^{\circ}C$	<u>[1]</u> -	1	А
		$T_{sp} \le 145 \ ^{\circ}C$	-	1	А
I <sub>FSM</sub>	non-repetitive peak forward current	square wave; t <sub>p</sub> = 8 ms	[2] -	50	А
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[3][4]	625	mW
			[3][5]	1050	mW
			[3][1]	2100	mW

#### **1 A low V<sub>F</sub> MEGA Schottky barrier rectifier**

#### Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
T <sub>j</sub>	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.

[2]  $T_j = 25 \text{ °C prior to surge.}$ 

[3] Reflow soldering is the only recommended soldering method.

- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [5] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

### 6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from	in free air	<u>[1][2]</u>			
	junction to ambient		[3] _	-	200	K/W
			[4] -	-	120	K/W
			[5] _	-	60	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		<u>[6]</u> _	-	12	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

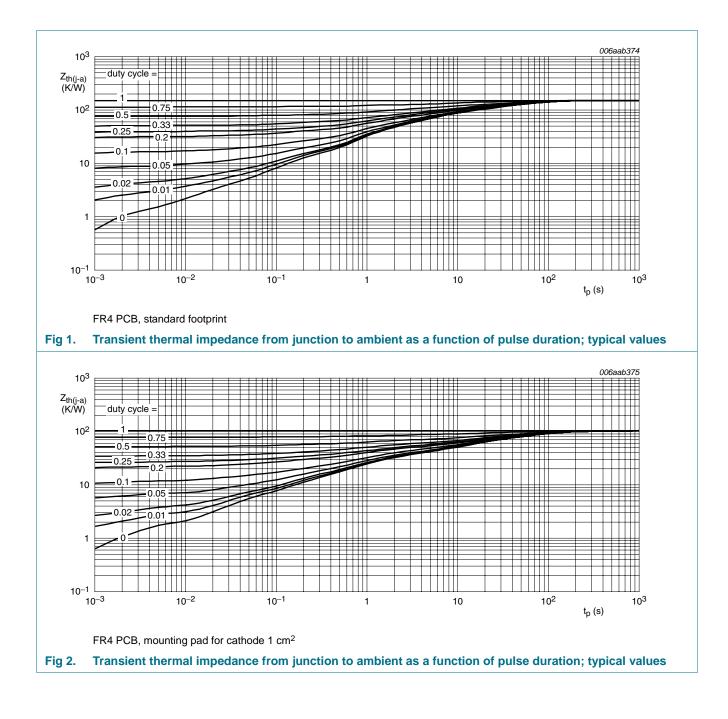
[5] Device mounted on a ceramic PCB,  $Al_2O_3$ , standard footprint.

[6] Soldering point of cathode tab.

#### **NXP Semiconductors**

# PMEG6010EP

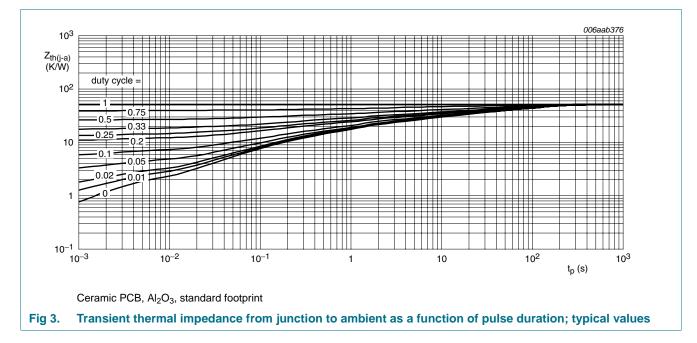
#### 1 A low V<sub>F</sub> MEGA Schottky barrier rectifier



#### **NXP Semiconductors**

# PMEG6010EP

#### 1 A low V<sub>F</sub> MEGA Schottky barrier rectifier



#### 7. **Characteristics**

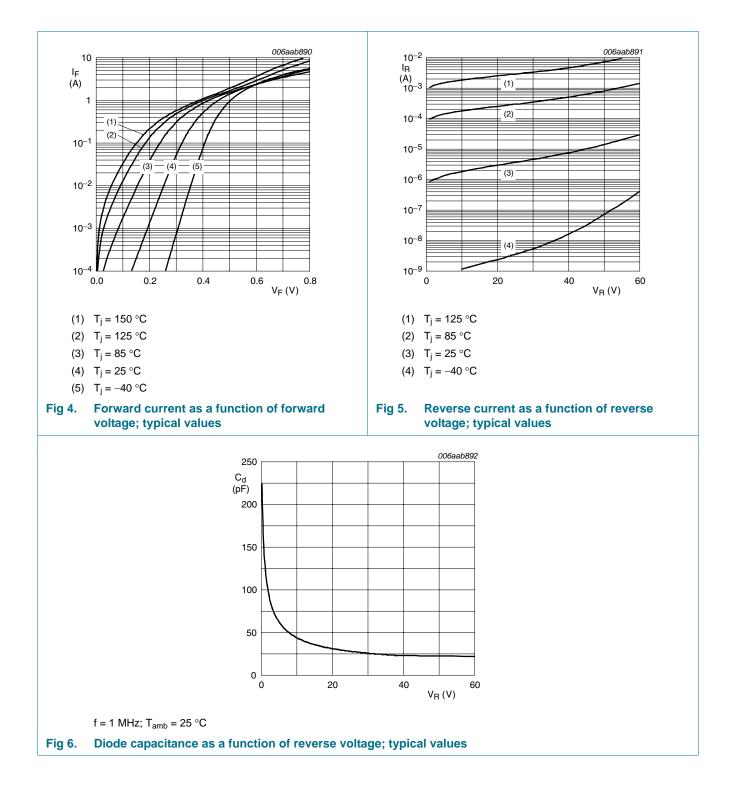
Characteristics Table 7.

$T_i = 25 \ ^{\circ}C \ unless$	otherwise	specified.
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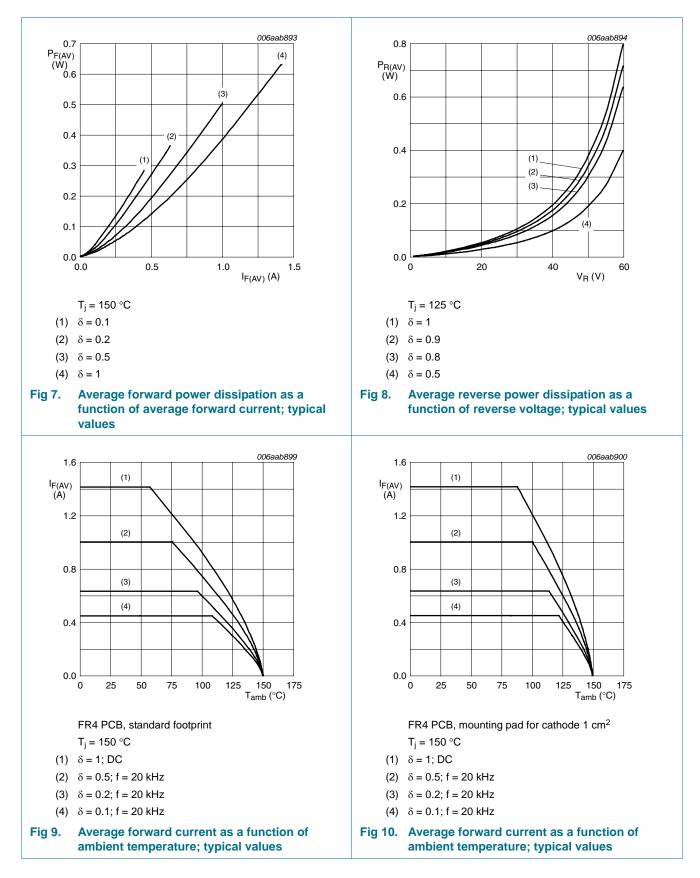
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	V <sub>F</sub> forward voltage	I <sub>F</sub> = 0.1 A	-	320	370	mV
	I <sub>F</sub> = 0.7 A	-	430	490	mV	
		I <sub>F</sub> = 1 A	-	460	530	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 5 V	-	1.2	-	μΑ
		V <sub>R</sub> = 10 V	-	1.7	-	μΑ
		V <sub>R</sub> = 60 V	-	30	60	μΑ
C <sub>d</sub>	diode capacitance	f = 1 MHz				
		$V_R = 1 V$	-	120	-	pF
		V <sub>R</sub> = 10 V	-	40	-	pF

PMEG6010EP\_1

#### 1 A low V<sub>F</sub> MEGA Schottky barrier rectifier

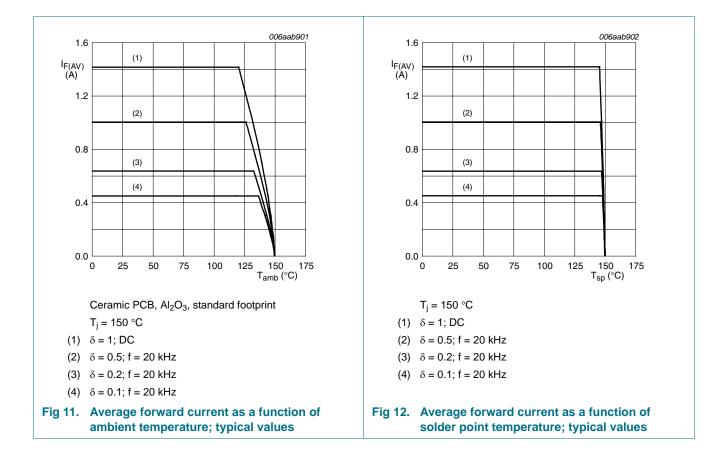


#### 1 A low V<sub>F</sub> MEGA Schottky barrier rectifier



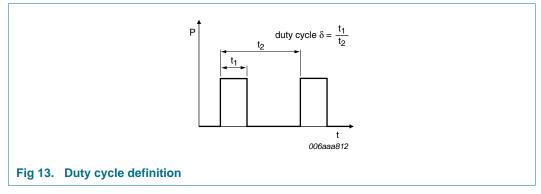
PMEG6010EP 1

#### 1 A low V<sub>F</sub> MEGA Schottky barrier rectifier



#### 1 A low V<sub>F</sub> MEGA Schottky barrier rectifier

### 8. Test information



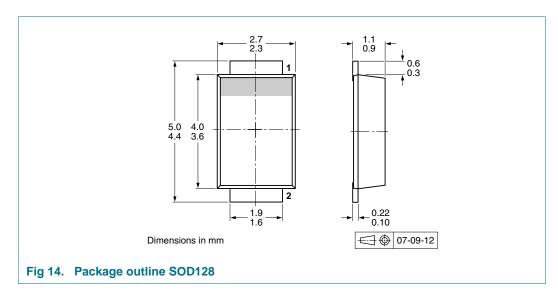
The current ratings for the typical waveforms as shown in Figure 9, 10, 11 and 12 are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,

 $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with I<sub>RMS</sub> defined as RMS current.

#### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

# 9. Package outline



PMEG6010EP\_1
Product data sheet

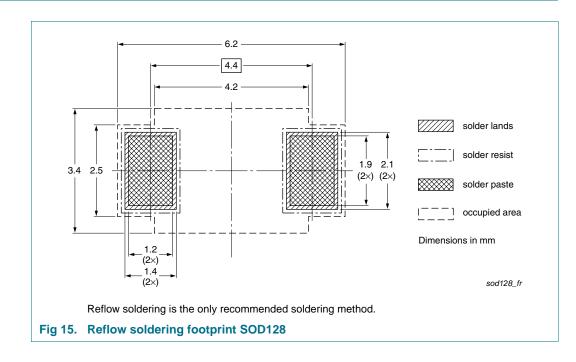
1 A low V<sub>F</sub> MEGA Schottky barrier rectifier

### **10.** Packing information

	king methods	three digits of the 12NC ordering code.[1]	
Type number	Package	Description	Packing quantity
			3000
PMEG6010EP	SOD128	4 mm pitch, 12 mm tape and reel	-115
[1] For further inf	armation and th	a availability of positing methods, and Caption 14	

#### [1] For further information and the availability of packing methods, see <u>Section 14</u>.

### 11. Soldering



### 1 A low V<sub>F</sub> MEGA Schottky barrier rectifier

### **12. Revision history**

Table 9. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PMEG6010EP_1	20100317	Product data sheet	-	-

#### 1 A low V<sub>F</sub> MEGA Schottky barrier rectifier

### **13. Legal information**

#### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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Product data sheet

1 A low V<sub>F</sub> MEGA Schottky barrier rectifier

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### **14. Contact information**

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#### 1 A low V<sub>F</sub> MEGA Schottky barrier rectifier

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